Chip Bead Cores

Type: EXCCL EXCML EXC3B

Discontinued

Features

- Effective noise suppression for power lines and high speed signal lines
- Easy pattern layout on PC Board
- RoHS compliant

Type: EXCCL, EXCML

- Low DC Resistance 3 to 8 mΩ typical: Rated current (3 and 4 Amperes) (type: EXCML)
- Low impedance

Type: EXC3B

- High impedance for high speed signal line noise
- Increased attenuation
- 60 Ω-1 A, 120 Ω-0.5 A are achieved by using 1608 size (type: EXC3BP)

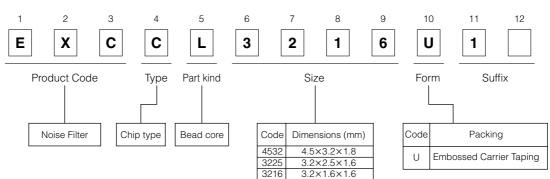


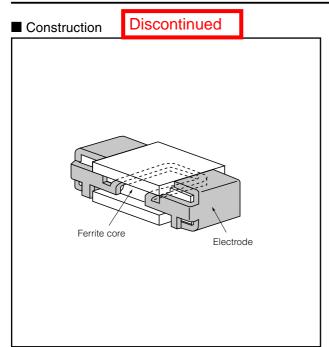
Recommended Applications

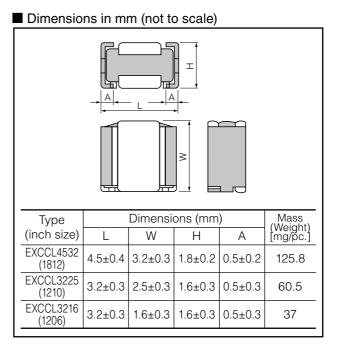
- Digital equipment such as PCs, word processors, printers, HDD, PCC, CD-ROMs, DVD-ROMs.
- Digital audio and video equipment such as VCRs, DVC, CD Players, DVD Players.
- AC adapters, and switching power supplies.
- Electronic musical instruments, and other digital equipment.

Type: EXCCL

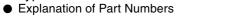
• Explanation of Part Numbers

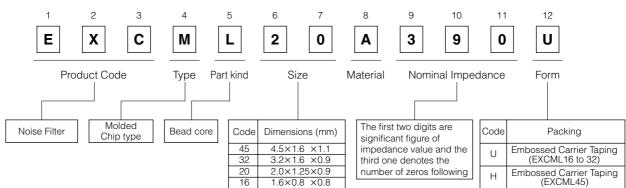


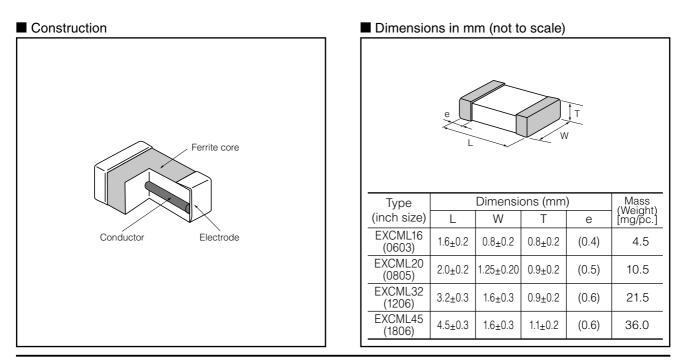




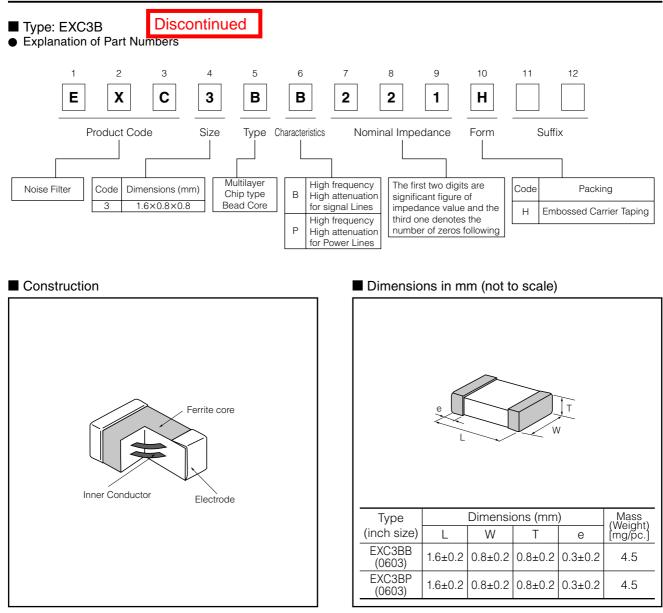
Type: EXCML







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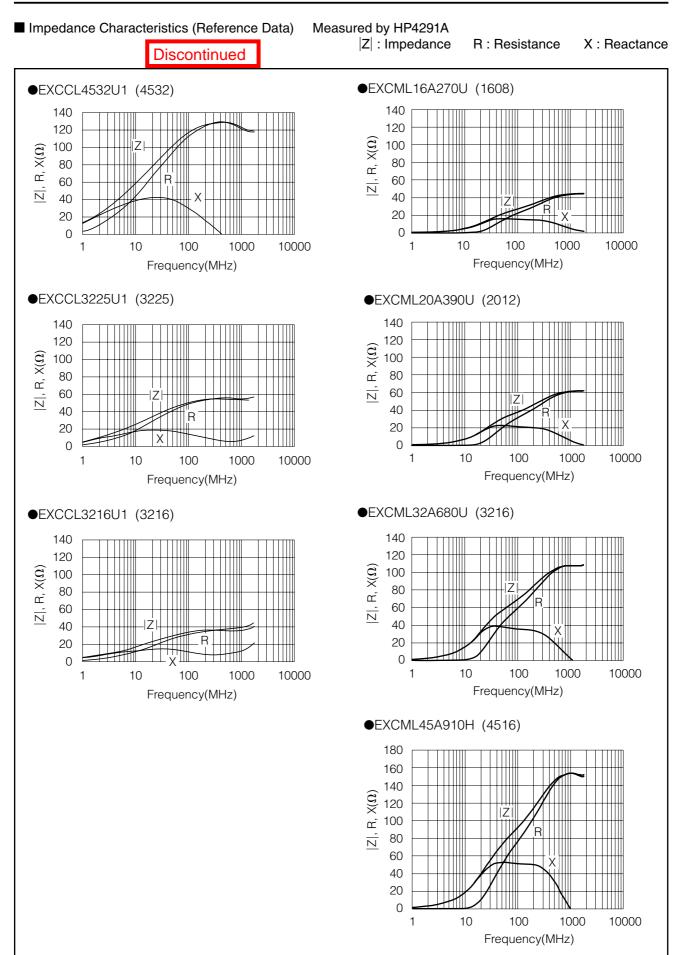


Ratings

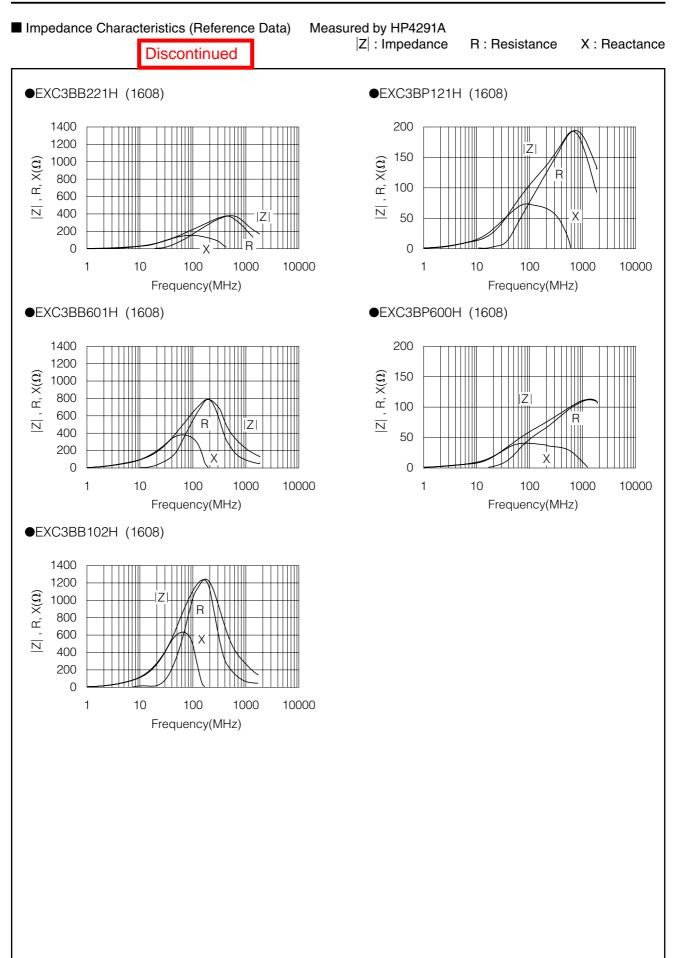
Туре	Part Number	Impedan	ce	Rated Current	DC Resistance
	Part Number	(Ω) at 100 MHz	tol.(%)	(mA DC)	(Ω) max.
4532	EXCCL4532U1	115 45		2000	0.1
3225	EXCCL3225U1			2000	0.05
3216	EXCCL3216U1	25		2000	0.05
4516	EXCML45A910H	91		3000	0.016
3216	EXCML32A680U	68		3000	0.012
2012	EXCML20A390U	39	±25	4000	0.008
1608	EXCML16A270U	27	±23	4000	0.006
1608	EXC3BP600H	60		1000	0.07
	EXC3BP121H	120		500	0.1
	EXC3BB221H	220		200	0.3
	EXC3BB601H	600		100	0.8
	EXC3BB102H	1000		50	1

● Category Temperature Range –25 °C to +85 °C

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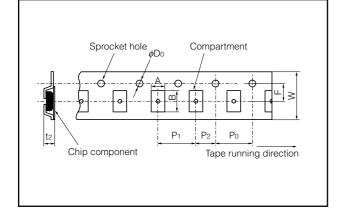


Chip Bead Cores

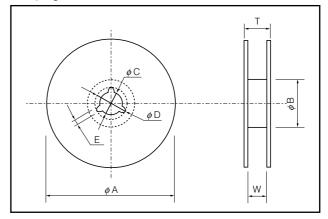
 Packaging Methods (Taping) Standard Quantity 	Discontinued

		•	
Part Number	Kind of Taping	Pitch (P ₁)	Quantity
EXCCL4532U1	Embossed Carrier Taping	8 mm	1000 pcs./reel
EXCCL3225U1			
EXCCL3216U1			2000 pcs./reel
EXCML45A910H			2000 pag /rool
EXCML32A680U		4 mm	3000 pcs./reel
EXCML20A390U			
EXCML16A270U			4000 pcs./reel
EXC3B			

• Embossed Carrier Taping



• Taping Reel



Embossed Carrier Dimensions (mm)

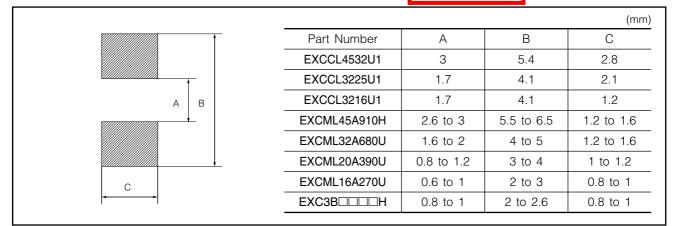
Part Number	A	В	W	F	P ₁	P ₂	P ₀	ϕD_0	t ₂
EXCCL4532U1	3.6±0.2	4.9±0.2	12.0±0.2	5.5±0.1	8.0±0.1				2.4 max.
EXCCL3225U1	2.9±0.2	3.6±0.2	8.0±0.2	3.5±0.1					2.1 max.
EXCCL3216U1	2.0±0.2	3.6±0.2	0.0±0.2	3.5±0.1					2.1 Max.
EXCML45A910H	1.9±0.2	4.8±0.2	12.0±0.2	5.5±0.1	4.0±0.1	2.0±0.1	4.0±0.1	1.5±0.1	1.8 max.
EXCML32A680U	1.9±0.2	3.5±0.2							
EXCML20A390U	1.5±0.2	2.3±0.2	8.0±0.2	3.5±0.1					1.6 max.
EXCML16A270U	1.0±0.2	1.8±0.2	0.0±0.2	.2 3.5±0.1					1.0 max.
EXC3B	1.0±0.1	1.8±0.1							

Standard Reel Dimensions (mm)

Part Number	φA	φB	φC	φD	E	W	Т
EXCCL4532U1						13.0±0.3	16.5 max.
EXCCL3225U1						9.0±0.3	13 max.
EXCCL3216U1						9.0±0.3	13 max.
EXCML45A910H	180.0 _{-3.0}	60.0±1.0	13.0±0.5	21.0±0.8	2.0±0.5	13.0±0.3	16.5 max.
EXCML32A680U							
EXCML20A390U						9.0±0.3	13 max.
EXCML16A270U						9.0±0.3	13 max.
EXC3B							

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Recommended Land Pattern Dimensions in mm (not to scale) Discontinued

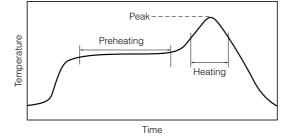


Recommended Soldering Conditions

Recommendations and precautions are described below.

Recommended soldering conditions for reflow

- · Reflow soldering shall be performed a maximum of two times.
- · Please contact us for additional information when used in conditions other than those specified.
- · Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



For soldering (E	Example : Sn-37Pb)
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	Temperature	Time	
Preheating	140 °C to 160 °C	60 s to 120 s	
Main heating	Above 200 °C	30 s to 40 s	
Peak	235 + 10 °C	max 10 s	

For lead-free	soldering	(Example ·	Sn/3Aa/0.5Cu)

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	Temperature	Time		
Preheating	150 °C to 170 °C 60 s to 12			
Main heating	Above 230 °C	30 s to 40 s		
Peak	max. 260 °C	max. 10 s		

Flow soldering

· Flow soldering may cause this product to come off because the adhesiveness of the product element is low. Please consult our sales representative in advance about flow soldering.

<Repair with hand soldering>

- Preheat with a blast of hot air or similar method. Use a soldering iron with a tip temperature of 350 °C or less. Solder each electrode for 3 seconds or less.
- Never touch this product with the tip of a soldering iron.

▲ Safety Precautions

The following are precautions for individual products. Please also refer to the common precautions for Noise Suppression Device shown on this catalog.

- 1. Use rosin-based flux or halogen-free flux.
- 2. For cleaning, use an alcohol-based cleaning agent. Before using any other type, consult with our sales person in advance.
- 3. Do not apply shock to Chip Bead Cores (hereafter called the bead cores) or pinch them with a hard tool (e.g. pliers and tweezers). Otherwise, their bodies may be chipped, affecting their performance. Excessive mechanical stress may damage the bead cores. Handle with care.
- 4. Store the bead cores in a location with a temperature ranging from -5 °C to +40 °C and a relative humidity of 40 % to 60 %, where there are no rapid changes in temperature or humidity.
- 5. Use the bead cores within a year (EXC3B Type: within half a year) after the date of the outgoing inspection indicated on the packages.

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